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FACSIMILE COVER SHEET

To Commissioner of Patents and Trademarks	Total Pages Sent: 10 (including cover sheet)
Facsimile Number: (703) 872-9306	Transmission Date: March 31, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Su, *et al.* Docket No.: TSM03-0150  
Serial No: 10/675,862 Art Unit: 2812  
Date Filed: September 30, 2003  
Title: Apparatus and Method for Manufacturing a Semiconductor Wafer With  
Reduced Delamination and Peeling

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at (703) 872-9306 on the date shown above:

- Facsimile Transmission Certification (1 page)
- Request Under 37 C.F.R. §1.48 (2 duplicate pages)
- Statement of Chenming Hu Requesting Change in Inventorship (1 page)
- Statement of Assignee Agreeing to Change in Inventorship (2 pages)
- Supplemental Declaration (4 pages)

Respectfully submitted,

  
Julie Russell  
Legal Assistant

Confirmation Respectfully Requested

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Applicants: Su, *et al.* Attorney Docket: TSM03-0150  
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Filed: September 30, 2003 Examiner: Unknown  
For: Apparatus And Method For Manufacturing A Semiconductor Wafer With Reduced  
Delamination And Peeling

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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**REQUEST UNDER 37 C.F.R. § 1.48**

This is a request for correction in inventorship in the above patent application. In accordance with 37 C.F.R. § 1.48, Applicants assert that the failure to include the eighth inventor's name, Chenming Hu, arose without any deceptive intention and was inadvertent on the part of the Applicants. The statements required under 37 C.F.R. § 1.48 are attached.

The fee of \$130.00 required under 37 C.F.R. § 1.17(i) is authorized to be charged to Deposit Account No. 50-1065. Please charge any additional fees required by this paper or credit any overpayment to this account. A duplicate of this paper is attached.

Respectfully submitted,



James C. Kesterson  
Attorney for Applicants  
Reg. No. 25,882

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Serial No.:	10/675,862	Art Unit:	2812
Filed:	September 30, 2003	Examiner:	Unknown
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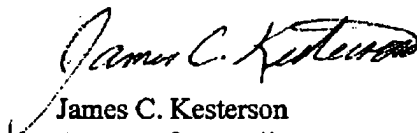
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James C. Kesterson  
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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:	Su, <i>et al.</i>	Attorney Docket:	TSM03-0150
Serial No.:	10/675,862	Art Unit:	2812
Filed:	September 30, 2003	Examiner:	Unknown
Title:	Apparatus And Method For Manufacturing A Semiconductor Wafer With Reduced Delamination And Peeling		

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Alexandria, VA 22313-1450

**STATEMENT OF CHENMING HU REQUESTING CHANGE IN INVENTORSHIP  
PURSUANT TO 37 C.F.R. 1.324(b)(1)**

The inventorship error of failing to include Chenming Hu as an inventor of the patent application occurred without any deceptive intention on the part of Chenming Hu.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application, any patent issued thereon, or any patent to which this declaration is directed.

March 26, 2004

Date

Chenming Hu

Chenming Hu

TSM03-0150

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE****OFFICIAL**

Applicants: Su, *et al.* Docket No.: TSM03-0150  
Serial No.: 10/675,862 Art Unit: 2812  
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**STATEMENT OF ASSIGNEE AGREEING TO CHANGE IN INVENTORSHIP**

Pursuant to 37 C.F.R. § 1.48(a)(5), Assignee Taiwan Semiconductor Manufacturing Company, Ltd., hereby states that it agrees with the following correction to the above-identified patent application:

1. Addition of Chenming Hu, 19-3, No. 50 University Rd., Hsin-Chu, Taiwan, R.O.C. as an inventor.

Pursuant to 37 C.F.R. § 3.73(b), the chain of title from the original owner to the current assignees may be located in the following records:

1. Assignment from inventors Su, Tsao, Lee, Huang, Hou, Jeng and Tsai to Taiwan Semiconductor Manufacturing Company, Ltd., (copy attached) was filed January 5, 2004. The reel/frame are unknown at this time.

TSM03-0150

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application, any patent issued thereon, or any patent to which this declaration is directed.

I am authorized to act on behalf of the assignee.

Name of Assignee: Taiwan Semiconductor Manufacturing Company, Ltd.

  
Signature of person signing for assignee

March 31, 2004  
Date

Chien-Wei(Chris) Chou  
Director of Intellectual Property Division

TSM03-0150

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